

APPROVAL SHEET

MR18X, MR20X, MR25X

±1%, ±5%

Power chip resistors

Size 1218, 2010, 2512
Automotive & Military Compliant

RoHS 2 Compliant with exemption 7C-1 Halogen free

*Contents in this sheet are subject to change without prior notice.



FEATURE

- 1. High power rating and compact size
- 2. High reliability and stability
- 3. Automotive AEC Q-200 compliant
- 4. 100% CCD visual inspection
- 5. RoHS 2 compliant with exemption 7C-1 and Halogen free products

APPLICATION

- Power supply
- Industry
- Motor control
- M/B Computer
- Automotives
- Servo

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.



Fig 1. Construction of 2512, 2010 Chip-R

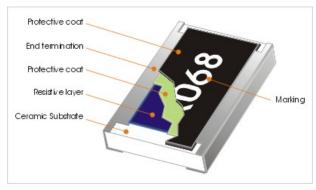


Fig 2. Construction of 1218 Chip-R

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QUICK REFERENCE DATA

Item	General Specification		
Series No.	MR18	MR20	MR25
Size code	1218(3248)	2010 (5025),	2512(6432)
Resistance Tolerance	±!	5% (E24); ±1% (E24+E9	6)
Resistance Range	,	$1\Omega \sim 10 M\Omega$, Jumper (0Ω)
TCR (ppm/°C) < 10Ω	± 200 ppm/°C	± 200 ppm/°C	± 200 ppm/°C
10Ω ~ 1ΜΩ	± 100 ppm/°C	± 100 ppm/°C	± 100 ppm/°C
> 1MΩ	± 200 ppm/°C	± 200 ppm/°C	± 200 ppm/°C
Max. dissipation at T _{amb} =70°C	1W	0.75 W	1W
Max. Operation Voltage (DC or RMS)	200V	200V	250V
Max. Overload Voltage (DC or RMS)	400V	400V	500V
Climatic category (IEC 60068)		55/155/56	

Test conditions for jumper (0 ohm)

			4 11.
Туре	MR18X	MR20X	MR25X
Power Rating At 70C	1 W	3/4 W	1.W
Resistance	Max. 50mR	Max. 50mR	Max. 50mR
Rated Current	4.5 A	3.2 A	4.5 A
Peak Current	11 A	PASSEV 8 AVSTEM A	LIANCE 11 A
Operating Temperature	景句	-55C ~ 155°C	多度

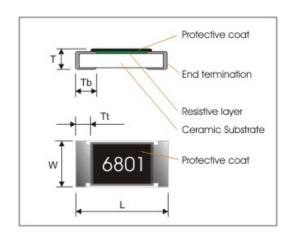
Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{Rated Power \times Resistance \ Value}$ or Max. RCWV listed above, whichever is lower.

MECHANICAL DATA (unit: mm)

TYPE	MR18	MR20	MR25	
L	3.05±0.15	5.00±0.20	6.40±0.20	
W	4.60±0.20	2.50±0.20	3.20±0.20	
Т	0.55±0.10	0.55±0.10	0.60±0.10	
Tt	0.45±0.25	0.65±0.25	0.65±0.25	
Tb	0.50±0.25	0.60±0.25	0.90±0.25	



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MARKING

Each resistor is marked with a four-digit code on the protective coating to designate the nominal resistance value $\pm 5\%, \pm 1\%$ tolerance!

Size	±5%	±1%	
2512, 2010, 1218	4-digits marking	4-digits marking	

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of $\pm 5\%$ & $\pm 1\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063".

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.3

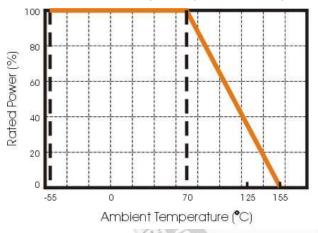


Fig 3 Maximum dissipation in percentage of rated power as a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 4.

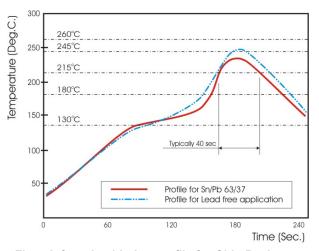


Fig 4. Infrared soldering profile for Chip Resistors

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CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

MR25	x	472_	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination
MR25 : 2512	X :	±5%: E24: 2 significant digits	F:±1%	T : 7" Reeled taping	code
MR20 : 2010	±5%: 1Ω-10ΜΩ	followed by no. of zeros	J : ±5%	Q : 10" Reeled taping	L = Sn base (lead free)
MR18 : 1218	±1%: 10Ω-1MΩ	100Ω = 101_	P : Jumper	G : 13" Reeled taping	,
	W :	$10K\Omega = 103$		B : Bulk	
	\pm 1%: < 10Ω; >1ΜΩ	±1%: E96: 3 significant digits followed by no. of zeros			
		102Ω =1020			
		37.4KΩ =3742			

^{* 100%} CCD visual inspection to guarantee visual quality!

TEST AND REQUIREMENTS

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

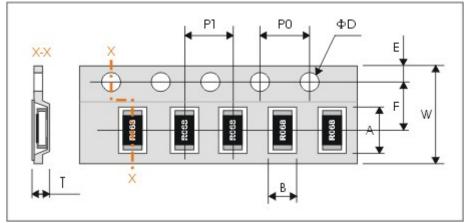
TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
IESI	PROCEDURE / TEST WIETHOD	Resistor	0Ω
Electrical	- DC resistance values measurement	Within the specified tolerance	
Characteristics	- Temperature Coefficient of Resistance (T.C.R)	Refer to "QUICK REFERENCE DAT	A"
	Natural resistance change per change in degree centigrade.		
JISC5201-1: 1998	$R_2 - R_1$		
Clause 4.8	$ \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20^{\circ}\text{C} + 5^{\circ}\text{C} - 1^{\circ}\text{C} $		
	R ₁ : Resistance at reference temperature		
	R ₂ : Resistance at test temperature		
Resistance to	Un-mounted chips completely immersed for 10±1second in a SAC	Δ R/R max. \pm (0.5%+0.05 Ω)	
soldering heat	solder bath at 270°C±5°C	No visible damage	
(R.S.H)			
MIL-STD-202 method 210			



TEOT	PROCEDURE (TEXT METURE)	REQUIREMENT		
TEST	PROCEDURE / TEST METHOD	Resistor	0Ω	
Solderability J-STD-002	 a) Bake the sample for 155°C dwell time 4hrs/ solder dipping 235°C / 5sec. b) Steam the sample dwell time 1 hour/ solder dipping 	95% coverage min., good tinning	and no	
	260°C/7sec.	visible damage		
Temperature cycling	1000 cycles, -55°C ~ +155°C, dwell time 5~10min	Δ R/R max. \pm (0.5%+0.05 Ω)		
JESD22		No visible damage	<50mΩ	
Method JA-104				
Moisture Resistance	65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle	Δ R/R max. \pm (0.5%+0.05 Ω)		
MIL-STD-202		No visible damage	$<$ 50m Ω	
method 106				
Bias Humidity	1000+48/-0 hours; 85°C, 85% RH, 10% of operation power	Δ R/R max. \pm (1.0%+0.05 Ω)		
MIL-STD-202		No visible damage	<50mΩ	
method 103				
Operational Life	1000+48/-0 hours; 35% of operation power, 125±2°C	Δ R/R max. \pm (1%+0.05 Ω)	.50	
MIL-STD-202 method 108	推所有 漫	No visible damage	<50mΩ	
High Temperature	1000+48/-0 hours; without load in a temperature chamber	Δ R/R max. \pm (1.0%+0.05 Ω)		
Exposure	controlled 155±3°C	No visible damage	<50mΩ	
MIL-STD-202	#	\	\ 0011152	
Method 108	PSA M	1		
Mechanical Shock	1/2 Sine Pulse / 1500g Peak / Velocity 15.4ft/sec	Within the specified tolerance		
MIL-STD-202	35	No visible damage	<50mΩ	
method 213	35. 1000			
Board Flex	Resistors mounted on a 90mm glass epoxy resin PCB(FR4),	Δ R/R max. \pm (1.0%+0.05 Ω).	<50mΩ	
AEC-Q200-005	bending once 2mm for 10sec	No visible damage		
Terminal strength AEC-Q200-006	Pressurizing force: 1.8Kg, Test time: 60±1sec.	No remarkable damage or ren the terminations	noval of	
Vibration	Test 5g's for 20min., 12 cycles each of 3 orientations	Δ R/R max. ±(1.0%+0.05Ω)		
MIL-STD-202		No visible damage	<50mΩ	
method 204				
Thermal shock	Test –55 to 155℃/ dwell time 15min/ Max transfer time 20sec	Δ R/R max. \pm (0.5%+0.05 Ω)		
MIL-STD-202	300cycles	No visible damage	<50mΩ	
method 107				
ESD	Test contact 3.0KV	Δ R/R max. \pm (1.0%+0.05 Ω).	<50mΩ	
AEC-Q200-002		No visible damage	-5011152	

PACKAGING

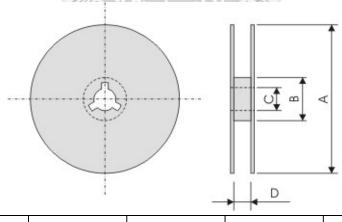
Plastic Tape specifications (unit :mm)



Туре	А	В	W	F	Е
MR18	4.90±0.20	3.55±0.30			
MR20	5.50±0.20	2.80±0.20	12.00±0.30	5.50±0.10	1.75±0.10
MR25	6.90±0.20	3.60±0.20			, i

	2.2.197			
Туре	P1	P0	ΦD	Т
MR18	8.00±0.10		Ф1.50-0.1	1.30±0.20
MR20	4.00±0.10	4.00±0.10		MAX1.2
MR25	4.00±0.10			IVIAA I.Z

Reel dimensions



Symbol	Α	В	С	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	14.0±0.2

Taping quantity

MR20, MR25 by plastic tape taping 4,000 pcs per reel.

MR18 by plastic tape taping 3,000 pcs per reel

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